

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	0	(semiconductor and package and comprising and substrate and first and side and opposing and second and plurality and die and contacts and multi and layer and metal and bumps and having and planar and tip and portions and pads and bonded and conductors and electrical and communication and bonding and sites and thereon and area and array and external and contacts and second and layered and bump and non-oxidizing and outer).clm.	US-PGPUB	OR	ON	2007/01/21 16:31